LD005 THRU LD10

SINGLE PHASE GLASS PASSIVATED SURFACE MOUNT FLAT BRIDGE RECTIFIER VOLTAGE: 50 TO 1000V CURRENT: 0.6A



FEATURE

MECHANICAL DATA

Terminal: Plated leads solderable per

Polarity: Polarity symbol marked on body

MIL-STD 202E, method 208C

Case:UL-94 Class V-0 recognized Flame Retardant Epoxy

Low profile space Ideal for automated placement Glass passivated chip Low forward voltage drop Low leakage current High forward surge capability High temperature soldering:260 °C/10 seconds at terminals

LDF 0.228(5.8) 0.213(5.4) (0.000) (0

Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half -wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated, for capacitive load, derate current by 20%)

	SYMBOL	LD 005	LD 01	LD 02	LD 04	LD 06	LD 08	LD 10	Units
Maximum Recurrent Peak Reverse Voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	Vrms	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $Ta = 40^{\circ}C$	lf(av)	0.6							A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	lfsm	20.0							A
Maximum Instantaneous Forward Voltage at forward current 0.3A	Vf	1.0							V
Maximum DC Reverse CurrentTa =25°Cat rated DC blocking voltageTa =125°C	lr	5.0 100.0							μA
Typical Thermal resistance (Note1)	Rth(ja)	70							°C/W
	Rth(jl)	20							
Typical Junction Capacitance (Note2)	Cj	13.0							pF
Storage and Operating Junction Temperature Range	Tstg, Tj	-55 to +150							°C

1. On aluminum substrate P.C.B. with an area of 0.8"×0.8"(20×20mm) mounted on 0.05×0.05"(1.3×1.3mm) solder pad 2. Measured at 1.0 MHz and applied voltage of 4.0 volt

Rev.A2

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